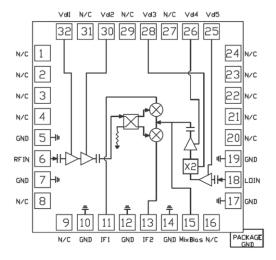


RFRX1701

GaAs MMIC IQ Downconverter 17.7GHz to 26.5GHz

RFMD's RFRX1701 is a 17.7GHz to 26.5GHz GaAs pHEMT

Downconverter, incorporating a low-noise amplifier, an integrated X2 LO frequency multiplier and buffer amplifier, and an image rejection mixer. The combination of high performance part and low cost packaging makes the RFRX1701 a cost effective solution, ideally suited to both current and next generation Point-to-Point Microwave Radio and Satellite Applications. RFRX1701 is packaged in a 5mm x 5mm QFN to simplify both system level board design and volume assembly.



Functional Block Diagram

RFRX1701PCBA-410 Evaluation board

Ordering Information

RFRX1701S2	Sample bag with 2 pieces				
RFRX1701SB	Bag with 5 pieces				
RFRX1701SQ	Bag with 25 pieces				
RFRX1701SR	100 Pieces				
RFRX1701TR7	7" Reel with 750 pieces				



Package: QFN, 32-pin, 5mm x 5mm x 0.95mm

Features

- RF Frequency: 17.7GHz to 26.5GHz
- LO Frequency: 6.85GHz to 15.25GHz
- IF Frequency: DC to 4GHzConversion Gain: 13dB
- Noise Figure: 2.5dB
- IIP3: 6dBm
- Image Rejection: 15dBc
- Low Cost 5mm x 5mm QFN Package

Applications

- Point-to-Point Radio
- Point-Multipoint Radio
- Satellite Communications
- Radar
- Electronic Warfare



Absolute Maximum Ratings

Parameter	Rating	Unit
LNA Drain Voltage (V _D)	6	V
LOA Drain Voltage (V _D)	6	V
RF Input Power	10	dBm
LO Input Power	15	dBm
T _{OPER}	-40 to +85	°C
T _{STOR}	-65 to +150	°C
ESD Human Body Model	Class 1A	



Caution! ESD sensitive device.



RFMD Green: RoHS compliant per EU Directive 2011/65/EU, halogen free per IEC 61249-2-21, <1000ppm each of antimony trioxide in polymeric materials and red phosphorus as a flame retardant, and <2% antimony solder.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

Nominal Operating Parameters

Dayamatar	Specification			11-26	0
Parameter	Parameter Min Typ Max	it Condition			
General Performance					
RF Frequency	17.7		26.5	GHz	
LO Frequency	6.85		15.25	GHz	
IF Frequency	DC		4.0	GHz	
LO Input Drive		+5		dBm	
Conversion Gain		13		dB	
NF (17.7GHz to 19.7GHz)		2.5		dB	
NF (21.2GHz to 23.6GHz)		2.7		dB	
NF (24.5GHz to 26.5GHz)		2.9		dB	
IIP3		6		dBm	
Image Rejection		15		dB	
LO-RF Isolation		40		dB	
LO-IF Isolation		15		dB	
LO Return Loss		12		dB	
RF Return Loss		12		dB	
V_D		3 to 5		V	
I _D		350		mA	

NOTES: Measurements performed on part soldered on evaluation board with SMA connectors and IF ports connected to an external 90° Hybrid Combiner and LO Power of +5dBm and at 25°C, unless otherwise stated.

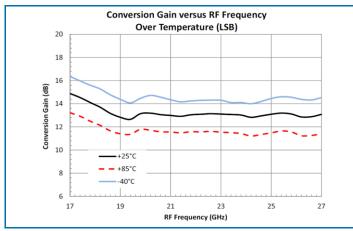
IF = 2.5GHz, RF Power = -20dBm, IIP3 is measured with a 2-tone input of -23dBm power for each tone and $\Delta f = 10MHz$, Vd1 = 3V, Vd2 = 4V, Vd3 through Vd5 = 5V, MixerBias = 0V

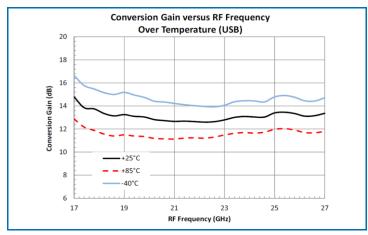
2 of 7

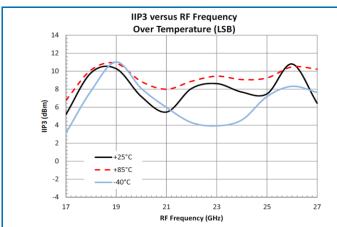


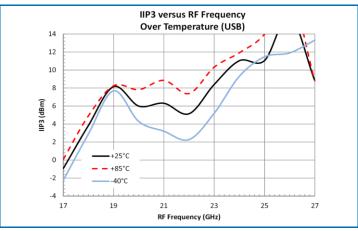
Typical Electrical Performance

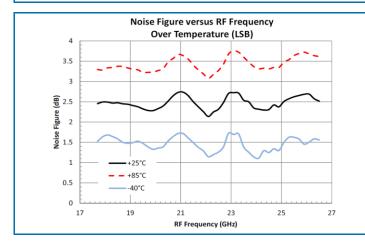
Measurements performed on part soldered on evaluation board with SMA connectors and IF ports connected to an external 90° Hybrid Combiner and LO Power of +5dBm, unless otherwise stated. IF = 2.5GHz, RF Power = -20dBm, IIP3 is measured with a 2-tone input of -23dBm power for each tone and $\Delta f = 10$ MHz, Vd1 = 3V, Vd2 = 4V, Vd3 through Vd5 = 5V, MixerBias = 0V.

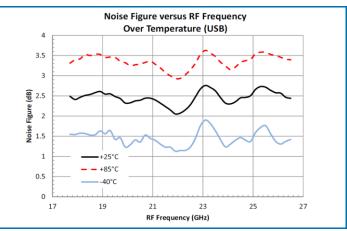






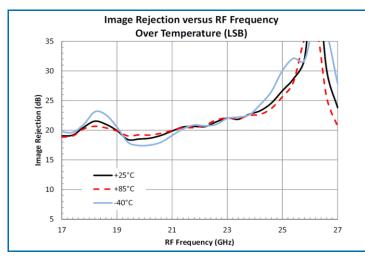


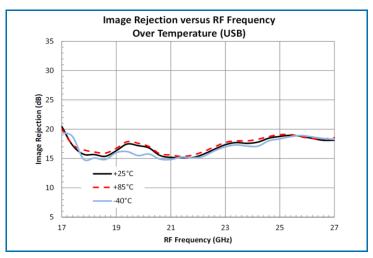


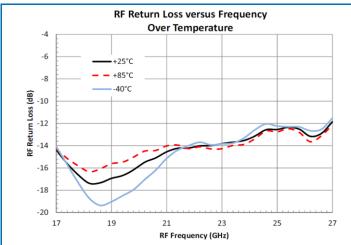


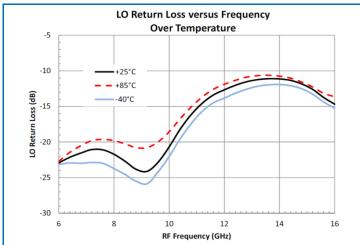


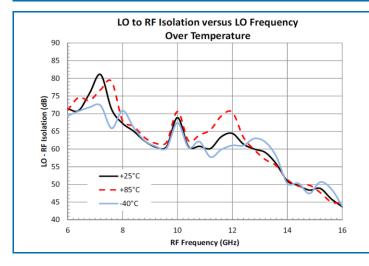
Typical Electrical Performance (continued)

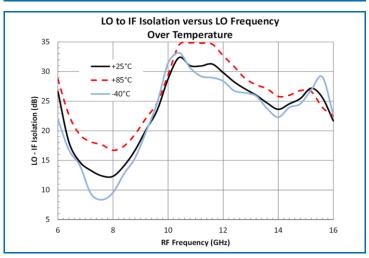






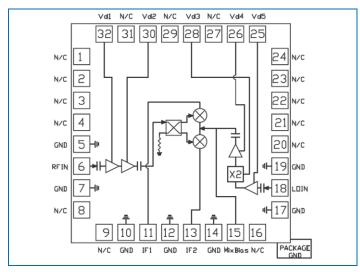








Pin Out



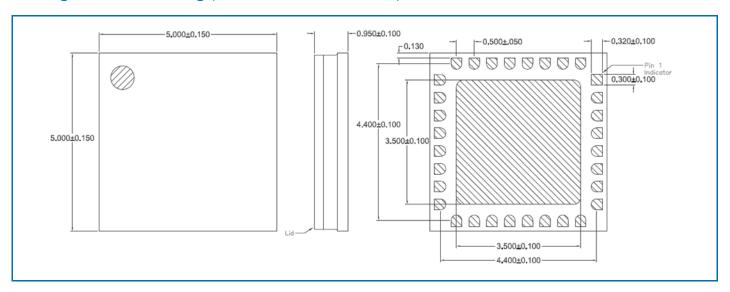
Pin Names and Descriptions

Pin	Name	Description						
1-4	N/C	Not Connected						
5	GND	Ground						
6	RF	RF Input, AC coupled and matched to 50Ω						
7	GND	Ground						
8-9	N/C	Not Connected						
10	GND	Ground						
11	IF1	IF1 Output						
12	GND	Ground						
13	IF2	IF2 Output						
14	GND	Ground						
15	Mixer Bias	Mixer Bias = 0V						
16	N/C	Not Connected						
17	GND	Ground						
18	LO	LO Input, AC coupled and matched to 50Ω						
19	GND	Ground						
20-24	N/C	Not Connected						
25	Vd5	Vd5 (LOA bias) = 5V						
26	Vd4	Vd4 (LOA bias) = 5V						
27	N/C	Not Connected						
28	Vd3	Vd3 (LOA bias) = 5V						
29	N/C	Not Connected						
30	Vd2	LNA drain bias2 = 4V						
31	N/C	Not Connected						
32	Vd1	LNA drain bias1 = 3V						

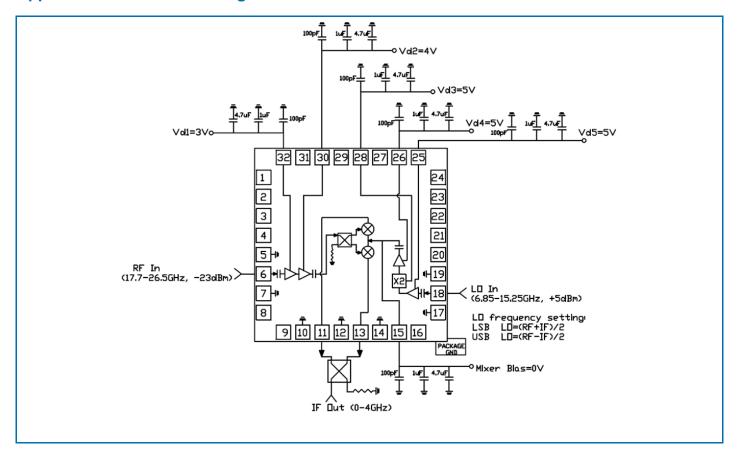
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Package Outline Drawing (Dimensions in millimeters)

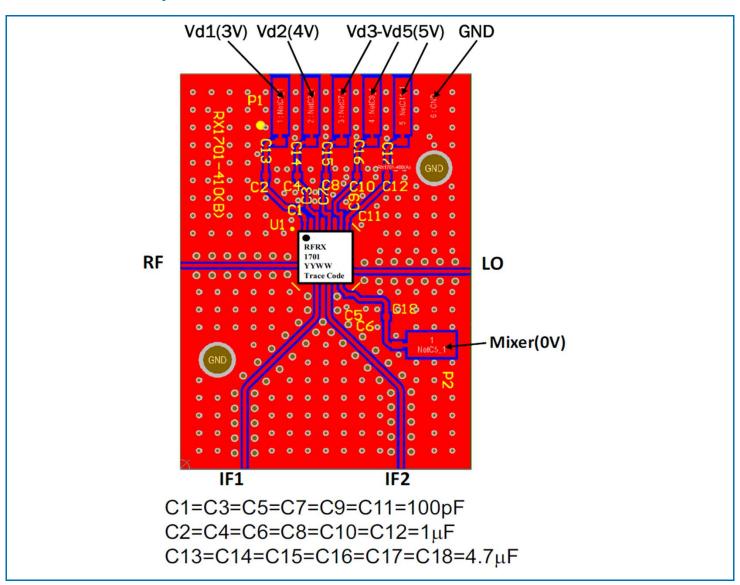


Application Circuit Block Diagram





Evaluation Board Layout



Test Conditions

LO Power	+5dBm
RF Power	-20dBm
Vd1	3.0V
Vd2	4.0V
Vd3, Vd4, Vd5	5.0V
Mixer Bias	0V